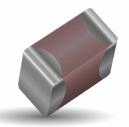
General Specifications





GENERAL DESCRIPTION

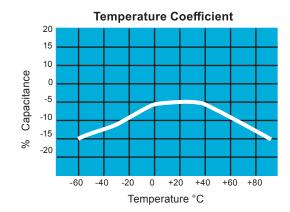
- · General Purpose Dielectric for Ceramic Capacitors
- EIA Class II Dielectric
- Temperature variation of capacitance is within ±15% from -55°C to +85°C
- Well suited for decoupling and filtering applications
- Available in High Capacitance values (up to 100μF)

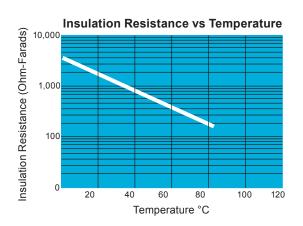
PART NUMBER (SEE PAGE 4 FOR COMPLETE PART NUMBER EXPLANATION)

1210	4	D	107	М	Α	Т	2	Α
	T	T	T	T	T	T	T	T
Size	Voltage	Dielectric	Capacitance	Capacitance	Failure	Terminations	Packaging	Special
(L" x W")	4 = 4V	D = X5R	Code (In pF)	Tolerance	Rate	T = Plated Ni	2 = 7" Reel	Code
0101**	6 = 6.3V		2 Sig. Digits +	$K = \pm 10\%$	A = N/A	and Sn	4 = 13" Reel	A = Std.
0201	Z = 10V		Number of	$M = \pm 20\%$				
0402	Y = 16V		Zeros					
0603	3 = 25V							
0805	D = 35V							A .
1206	5 = 50V							
1210	1 = 100V							The same of the sa
1812								
**EIA 010	005							RoHS
								COMPLIANT

NOTE: Contact factory for availability of Tolerance Options for Specific Part Numbers. Contact factory for non-specified capacitance values.

TYPICAL ELECTRICAL CHARACTERISTICS









Parame	ter/Test	X5R Specification Limits	Measuring C	onditions						
Operating Tem		-55°C to +85°C	Temperature Cycle Chamber							
Capac Dissipati	itance on Factor	Within specified tolerance ≤ 2.5% for ≥ 50V DC rating ≤ 12.5% for 25V, 35V DC rating ≤ 12.5% Max. for 16V DC rating and lower Contact Factory for DF by PN	Freq.: 1.0 kHz ± 10% Voltage: 1.0Vrms ± .2V For Cap > 10 μF, 0.5Vrms @ 120Hz							
Insulation	Resistance	10,000MΩ or 500MΩ - μF, whichever is less	Charge device with rate secs @ room te							
Dielectric	Strength	No breakdown or visual defects	Charge device with 250% seconds, w/charge and disto 50 mA	scharge current limited						
	Appearance	No defects	Deflection: 2mm							
Resistance to	Capacitance Variation	≤ ±12%	Test Time: 30) seconds 1mm/sec						
Flexure Stresses	Dissipation Factor	Meets Initial Values (As Above)								
	Insulation Resistance	≥ Initial Value x 0.3	90 m	m						
Solder	ability	≥ 95% of each terminal should be covered with fresh solder	Dip device in eutectic sold ± 0.5 sec							
	Appearance	No defects, <25% leaching of either end terminal								
	Capacitance Variation	≤ ±7.5%								
Resistance to Solder Heat Dissipation Factor Insulation Resistance		Meets Initial Values (As Above)	Dip device in eutectic solder at 260°C for 60seconds. Store at room temperature for 24 ± 2hours before measuring electrical properties.							
		Meets Initial Values (As Above)	2hours before measuring	j electrical properties.						
	Dielectric Strength	Meets Initial Values (As Above)								
	Appearance	No visual defects	Step 1: -55°C ± 2°	30 ± 3 minutes						
	Capacitance Variation	≤ ±7.5%	Step 2: Room Temp	≤ 3 minutes						
Thermal Shock	Dissipation Factor	Meets Initial Values (As Above)	Step 3: +85°C ± 2°	30 ± 3 minutes						
	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp ≤ 3 minutes							
	Dielectric Strength	Meets Initial Values (As Above)	Repeat for 5 cycles and measure after 24 ± 2 hours at room temperature							
	Appearance	No visual defects	Charge device with 1.5X rated voltage in tes							
	Capacitance Variation	≤ ±12.5%	chamber set at 85°C ± (+48, -	2°C for 1000 hours						
Load Life	Dissipation Factor	≤ Initial Value x 2.0 (See Above)	Note: Contact factory for part numbers that are to							
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	voltaç							
	Dielectric Strength	Meets Initial Values (As Above)	Remove from test chambe temperature for							
Appearance		No visual defects								
	Capacitance Variation	≤ ±12.5%	Store in a test chamber se 5% relative humidity for 10							
Load Humidity	Dissipation Factor	≤ Initial Value x 2.0 (See Above)	rated voltage	e applied.						
,	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	Remove from chamber a temperature and 24 ± 2 hours befo	humidity for						
	Dielectric Strength	Meets Initial Values (As Above)	24 ± 2 Hours Dero							





PREFERRED SIZES ARE SHADED

Case Size	Case Size 0101* 0201								0402						0603							0805						
Soldering			v Only		Re	flow 0	nlv			-		//Wav	e				Refl	ow/W						Ref	low/W			
Packaging		Paper/Er				II Pape						aper						II Pap								ossed		
(L) Length	mm (in.)	0.40 : (0.016 ±	± 0.02		0.0	60 ± 0. 24 ± 0.	09		1.00 ± 0.20 (0.040 ± 0.008)						1.60 ± 0.20 (0.063 ± 0.008)					2.01 ± 0.20 (0.079 ± 0.008)								
W) Width	mm (in.)	0.20 : (0.008 ±				30 ± 0. 11 ± 0.			0.50 ± 0.20 (0.020 ± 0.008)									30 ± 0 31 ± 0				1.25 ± 0.20 (0.049 ± 0.008)						
(t) Terminal	mm (in.)	0.10 : (0.004 ±				15 ± 0. 06 ± 0.						± 0.15 ± 0.00			0.35 ± 0.15 (0.014 ± 0.006)									50 ± 0 20 ± 0				
Voltage:		6.3	10	4	6.3	10	16	25	4	6.3	10	16	25	50	4	6.3	10	16	25	35	50	4	6.3	10	16	25	35	50
Cap (pF) 100	101		В					Α																				
150	151		В					Α																				
220	221		В					Α						С														
330	331		В					Α						С														
470	471		В					Α						С														
680	681		В					Α						С														
1000	102		В				Α	Α						С														
1500	152	В	В				Α	Α						С														
2200	222	В	В			Α	Α	Α						С														
3300	332	В	В			Α	Α	Α						С														
4700	472	В	В			Α	Α	Α					С								G							
6800	682	В	В			Α	Α	Α					С								G							
Cap (µF) 0.01	103	В	В			Α	Α	Α					С						G	G	G							
0.015	150	В											С						G	G	G							
0.022	223	В			Α	Α	Α	Α				С	С						G	G	G							N
0.033	333	В										С							G	G	G							N
0.047	473	В			Α	Α	Α	Α				С	С						G	G	G							N
0.068	689	В										С				ļ	ļ		G		G	<u> </u>			-			N
0.1	104	В			Α	Α	Α	Α			С	С	С	С					G	G	G					N	N	N
0.15	154	-								_				-					G				_		_	N	N	L
0.22	224	В		Α	Α	Α				С	С	С	С	С				G	G							N	N	N
0.33 0.47	334 474	В		Α		_			_	_	_	_	0	E	-	-	-	G	G		_	_	-		-	N	P	P
0.47	684	R		Α	Α				С	С	С	С	С	E		<u> </u>	-	G	J				-	-	-	N N	Р	Р
1.0	105			Λ.	Α	С	С	-	С	С	С	С	С		G	G	G	G	J	G	G	_	-	-	N	N	P	Р
1.0	155			Α	A	L	U		U	U	U	U	U		G	G	G	G	J	G	G				IN	IN	P P	P
2.2	225			С	С	С	-	-	С	С	С	С	С		G	G	J	J	J	К	K		-	N	N	Р	Р	Р
3.3	335			U	U	U	_	_	U	U	U	U	U		J	J	J	J	J		N.		N	N	IN	P	Р	Р
4.7	475			С	С		_		Е	Е	Е	Е		_	J	J	J	G	K		-	N	P	J	N	N	Р	Р
10	106								E	E	E				K	J	K	K	K			P	P	P	P	P		P
22	226				 		 		E	G			+		K	K	K	IX	IX			P	P	P	P	P		1
47	476			<u> </u>			_	<u> </u>		G			 		K	K	IX			-		P	P	P				
100	107				 	-	 			-	-	 	+		IX	IX	 		-				-		 	<u> </u>		
Voltage:	107	6.3	10	4	6.3	10	16	25	4	6.3	10	16	25	50	4	6.3	10	16	25	35	50	4	6.3	10	16	25	35	50
Case Size			01*		0.0	0201				0.0		02		1 00		0.0		0603		- 00	00		0.0		0805		, 00	_ 00
Out Size		J.				3201						-						3000							3000			

Letter	Α	В	С	E	G	J	K	М	N	Р	Q	Х	Υ	Z
Max. Thickness	0.33 (0.013)	0.22 (0.009)	0.56 (0.022)	0.71 (0.028)	0.90 (0.035)	0.94 (0.037)	1.02 (0.040)	1.27 (0.050)	1.40 (0.055)	1.52 (0.060)	1.78 (0.070)	2.29 (0.090)	2.54 (0.100)	2.79 (0.110)
			PAI	PER						EMBO	SSED			

PAPER and EMBOSSED available for 01005 NOTE: Contact factory for non-specified capacitance values *EIA 01005





PREFERRED SIZES ARE SHADED

Case Size					1206							1210							1812					
Soldering				Ref	low/W						Re	flow C						Re	flow 0					
Packaging				Paper	/Emb	ossec	t					r/Emb		ı					Embos					
(L) Length	mm (in.)				20 ± 0.				3.20 ± 0.40 (0.126 ± 0.016)								4.50 ± 0.30 (0.177 ± 0.012)							
	mm	(0.126 ± 0.016) 1.60 ± 0.30																	20 ± 0.					
W) Width	(in.)	(0.063 ± 0.012)								2.50 ± 0.30 (0.098 ± 0.012)														
(A) To	mm				50 ± 0							50 ± 0.				(0.126 ± 0.008) 0.61 ± 0.36								
(t) Terminal	(in.)			(0.02	20 ± 0						(0.0	20 ± 0	.010)					(0.0	24 ± 0					
Voltage:		4	6.3	10	16	25	35	50	4	6.3	10	16	25	35	50	4	6.3	10	16	25	35	50		
Cap (pF) 100	101																							
150	151																							
220	221																							
330	331																							
470	471																							
680	681																							
1000																								
1500																								
2200																								
3300																								
4700																								
6800																								
Cap (µF) 0.01	103																							
0.01																								
0.02																								
0.03																								
0.04																								
0.06																								
0.1	104																							
0.15																								
0.22																<u> </u>								
0.33																								
0.47	474					Q	Q							Х	Х									
0.68		-			_								V	V	V		_	_	_	-				
1.0	105					Q	Q	Q					Х	Х	Х			-	-					
1.5	155 225				_	0							V	7	7									
3.3	335			Q	Q	Q	Q	Q					Х	Z	Z									
4.7	475		Q	Q X	X	Х		Х			Z	Z	Z	Z	Z									
10	106	X	X	X	X	X	X	X		Х	X	Z	Z	Z	Z		_	\vdash	-	Z				
22	226	X	X	X	X	X	٨	٨	Z	Z	Z	Z	Z			Z	Z	Z	Z					
47	476	X	X	X	X	^			Z	Z	Z	Z	Z											
100	107	X	X	^	٨				Z	Z							-	-	-	-				
Voltage:	107	4	6.3	10	16	25	35	50	4	6.3	10	16	25	35	50	4	6.3	10	16	25	35	50		
Case Size		-	0.3	10	1206		33	30	-	0.3	10	1210	23	33	30	-	0.3	10	1812	23	33	30		
Jase Size					1210 1612																			

Letter	Α	В	С	E	G	J	K	М	N	P	Q	X	Υ	Z
Max.	0.33	0.22	0.56	0.71	0.90	0.94	1.02	1.27	1.40	1.52	1.78	2.29	2.54	2.79
Thickness	(0.013)	(0.009)	(0.022)	(0.028)	(0.035)	(0.037)	(0.040)	(0.050)	(0.055)	(0.060)	(0.070)	(0.090)	(0.100)	(0.110)
			PA	PER						EMBO:	SSED			

PAPER and EMBOSSED available for 01005

NOTE: Contact factory for non-specified capacitance values *EIA 01005



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